

High Current Button Rectifiers

FEATURES

- Diffused junction
- Low leakage
- High surge capability
- Low cost construction utilizing void-free molded plastic technique
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21 definition

MECHANICAL DATA

Case: AR

Molding compound, UL flammability classification rating 94V-0 Base P/N with suffix "G" on packing code - green compound (halogen-free) **Terminal:** Matte tin plated leads, solderable per JESD22-B102 Meet JESD 201 class 1A whisker test

Weight: 1.8 g (approximately)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS (T _A =25°C unless otherwise noted)										
PARAMETER	SYMBOL	AR	AR	AR	AR	AR	AR	AR	UNIT	
	25A 25B 25D 25G 25J 25H		25K	25M						
Maximum repetitive peak reverse voltage	V _{RRM}	50	100	200	400	600	800	1000	V	
Maximum RMS voltage	V _{RMS}	35	70	140	280	420	560	700	V	
Maximum DC blocking voltage	V _{DC}	50	100	200	400	600	800	1000	V	
Maximum average forward rectified current	I _{F(AV)}	25						А		
Peak forward surge current, 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	400						А		
Maximum instantaneous forward voltage (Note 1) @ 25 A	V _F	1.0					V			
Maximum reverse current @ Rated VR T _J =25 °C T _J =125 °C	I _R	5 250					μA			
Typical reverse recovery time (Note 2)	trr	3				μs				
Typical junction capacitance (Note 3)	Cj	300				pF				
Typical Thermal Resistance	R _{θJC}	1				^o C/W				
Operating junction temperature range	TJ	- 50 to +175				°C				
Storage temperature range	T _{STG}	- 50 to +175				OO				

Note 1: Pulse test with PW=300 μ s, 1% duty cycle

Note 2: Reverse Recovery Time Test Conditions: I_F=0.5A, I_R=1.0A, I_{RR}=0.25A

Note 3: Measured at 1 MHz and Applied Reverse Voltage of 4.0V D.C.











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ORDERING INFORMATION							
PART NO.	PACKING CODE	PACKING CODE	PACKAGE	PACKING			
		SUFFIX					
AR25x (Note 1)	B0	G	AR	1,000 / Bulk packing			

Note 1: "x" defines voltage from 50V (AR25A) to 1000V (AR25M)

EXAMPLE								
PREFERRED P/N PART NO. P		PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION				
AR25M B0	AR25M	B0						
AR25M B0G	AR25M	B0	G	Green compound				

RATINGS AND CHARACTERISTICS CURVES

 $(T_A=25^{\circ}C \text{ unless otherwise noted})$

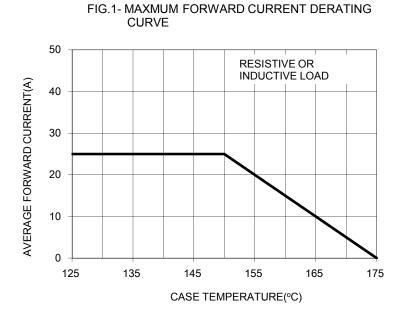


FIG. 3- MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

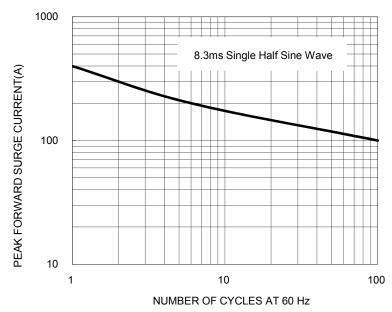


FIG. 2- TYPICAL REVERSE CHARACTERISTICS

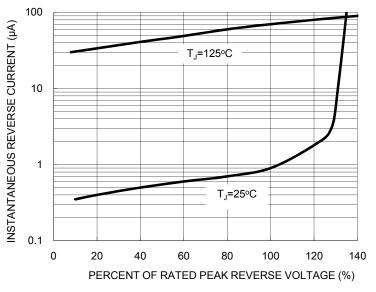
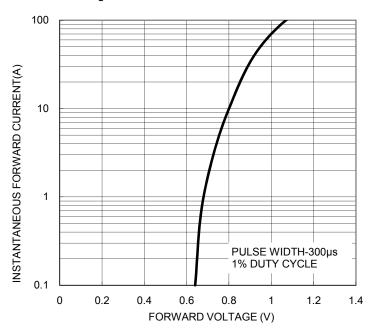


Fig. 4 TYPICAL FORWARD CHARACTERISTICS





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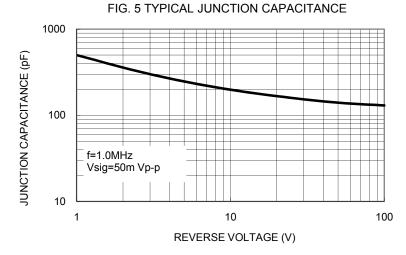
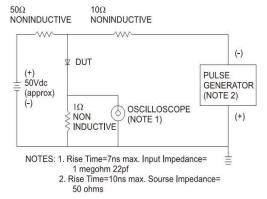
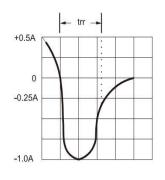
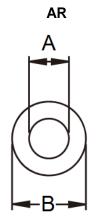


FIG.6- REVERSE RECOVERY TIME CHARACTERISTIC AND TEST CIRCUIT DIAGRAM

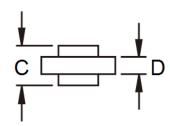




PACKAGE OUTLINE DIMENSIONS



DIM.	Unit	(mm)	Unit (inch)			
	Min	Max	Min	Max		
А	5.50	5.70	0.217	0.224		
В	9.70	10.40	0.382	0.409		
С	6.00	6.40	0.236	0.252		
D	4.20	4.70	0.165	0.185		



MARKING DIAGRAM



- P/N = Specific Device Code
 - Green Compound
- YW = Date Code

G =

F =

Factory Code



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